



S3A THRU S3M

VOLTAGE RANGE

50 to 1000 Volts

CURRENT

3.0 Ampere

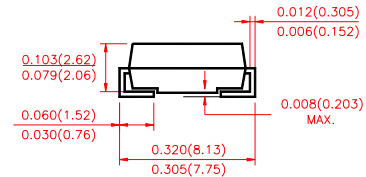
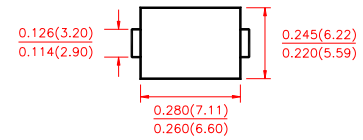
FEATURES

- Plastic package has underwrites laboratory flammability Classification 94V-0
- For surface mounted applications
- Low profile package
- Built-in strain relief, ideal for automated placement
- Glass Passivated chip junction
- High temperature soldering:
250°C/10 second at terminals

MECHANICAL DATA

- Case: JEDED DO-214AA molded plastic over glass passivated chip
- Terminals: Solder plated, Solderable per MIL-STD-750, method 2026
- Polarity: Color band denotes cathode end
- Weight: 0.007ounce, 0.25 gram

DO-214AB(SMC)



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

- Ratings at 25°C ambient temperature unless otherwise specified

	SYMBOLS	S3A	S3B	S3D	S3G	S3J	S3K	S3M	UNIT
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at $T_L=100^\circ\text{C}$ (NOTE 3)	$I_{(AV)}$	3.0							Amps
Peak Forward Surge Current 8.3ms single half sine wave superimposed on rated load (JEDEC method) $T_L=100^\circ\text{C}$	I_{FSM}	100							Amps
Maximum Instantaneous Forward Voltage at 3.0A	V_F	1.15							Volts
Maximum DC Reverse Current at rated DC Blocking Voltage	$T_A = 25^\circ\text{C}$	10.0							μA
	$T_A = 125^\circ\text{C}$	250							
Typical Reverse Recovery Time (NOTE 1)	T_{rr}	2.5							μs
Typical junction capacitance (NOTE 2)	C_J	60							pF
Typical Thermal Resistance (NOTE 3)	$R_{\theta JL}$	47							$^\circ\text{C}/\text{W}$
	$R_{\theta JA}$	13							
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150							$^\circ\text{C}$

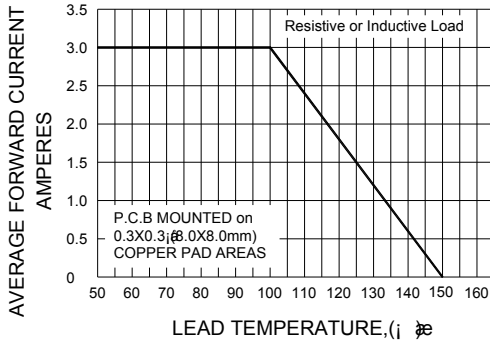
Notes:

1. Reverse recovery test conditions: $I_F=0.5\text{A}$, $I_R=1.0\text{A}$, $I_{rr}=0.25\text{A}$
2. Measured at 1.0MHz and applied reverse voltage of 4.0 Volts
3. Thermal resistance from Junction to ambient and from junction to lead mounted on P.C.B.with $0.3 \times 0.3''$ ($8 \times 8\text{mm}$) copper pad areas.

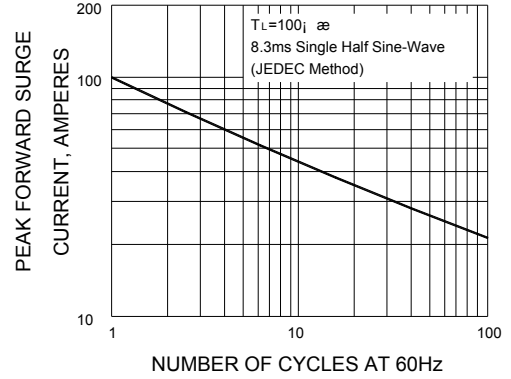


RATINGS AND CHARACTERISTIC CURVES S3A THRU S3M

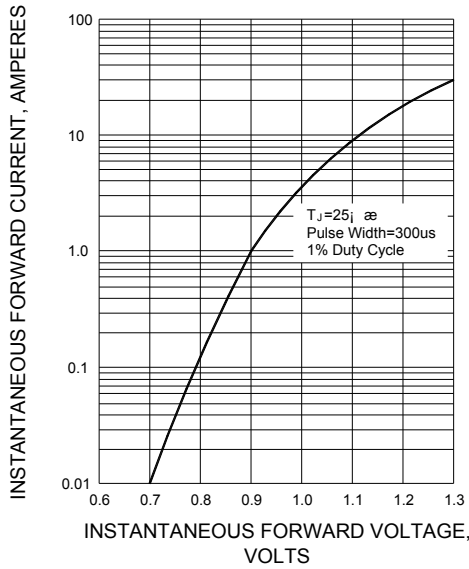
F1G.1-FORWARD CURRENT DERATING CURVE



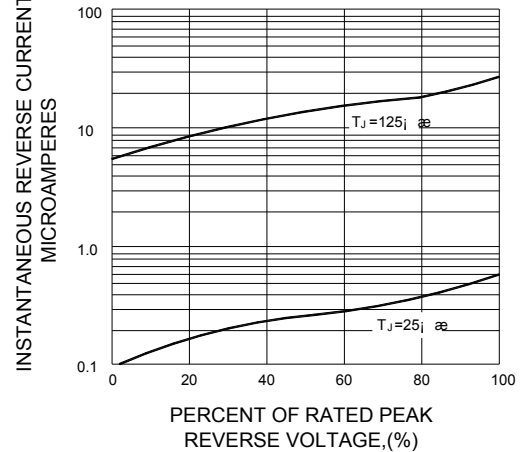
F1G.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT



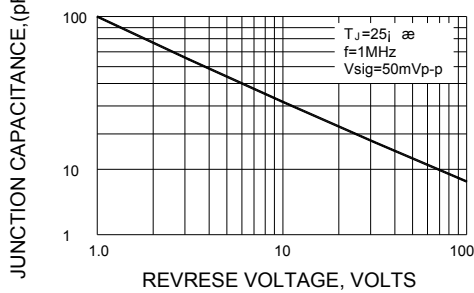
F1G.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS



F1G.4-TYPICAL REVERSE CHARACTERISTICS



F1G.5-TYPICAL JUNCTION CAPACITANCE



F1G.6-TYPICAL TRANSIENT THERMAL IMPEDANCE

